# 1206 Slow Blow SMD Fuses



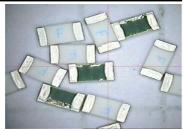






## Description

12S Series are the fuses set the industry standard for performance, reliability and quality. The solder-free design provides excellent on-off and temperature cycling characteristics during use and also makes our SMD fuses more heat and shock tolerant than typical subminiature fuses.



Electrical Characteristics						
Rated Current	1.0ln	2.5ln	3.0ln	3.5ln	10.0ln	
4.5A~5A	4 hour min.	5 sec max.	0.1sec - 3sec	-	0.2ms - 20ms	
6A~40A	4 hour min.	-	-	5 sec max.	0.2ms - 10ms	

#### **Features**

- > High inrush current withstanding capability
- > AEC-Q200 Automotive Grade Certified
- > Compatible with reflow and wave solder
- > Ceramic and glass construction
- > Excellent environmental integrity
- > One time positive disconnect
- ➤ Lead Free and Halogen free material

#### **Specifications**

Part No.	Rated		Rated Current	Breaking Capacity	Typical Cold. Resistance (mOhms) <sup>2</sup>	Typical Voltage Drop	Typical Pre- Arcing l <sup>2</sup> t	Alpha Mark
	Voltage		(1)	(A) <sup>1</sup>	(IIIOIIIIS)	(mV)	(A <sup>2</sup> Sec) <sup>3</sup>	
	D	C	(A)					
12S1450	72V 63V	32V	4.5	50A	27	164	2.65	Χ
12S1500			5	50A	22	145	4	Т
12S1600			6	50A	14.5	140	12	F
12S1700			7	50A	10.5	130	14	7
12S1800	48V - 36V	32V	8	200A	7.0	123	16	V
12S2100			10	200A	5.0	110	22	U
12S2120			12	200A	4.3	80	40	W
12S2150			15	200A	3.5	85	45	Υ
12S2200			20	200A	2.2	80	50	Q
12S2250			25	200A	1.55	90	58	L
12S2300			30	200A	1.32	90	95	Z
12S2400	`36V	32V	40	200A	0.85	95	240	XL

- 1. DC Interrupting Rating (Measured at rated voltage, time constant of less than 50 microseconds, battery source)
- 2. DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25°C
- 3. Typical Pre-arcing I<sup>2</sup>t are measured at 10In Current

Choice fuse for surge application (USB charger etc.), make sure the I<sup>2</sup>t of fuse is 4 times than surge. Specifications are subject to change without notice. Application testing is strongly recommended.





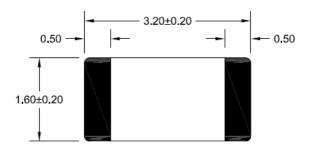




#### **Dimension**

Drawing not to scale (Unit: mm)

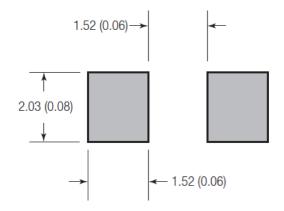
## Top view



Side view



## **Recommended land pattern**



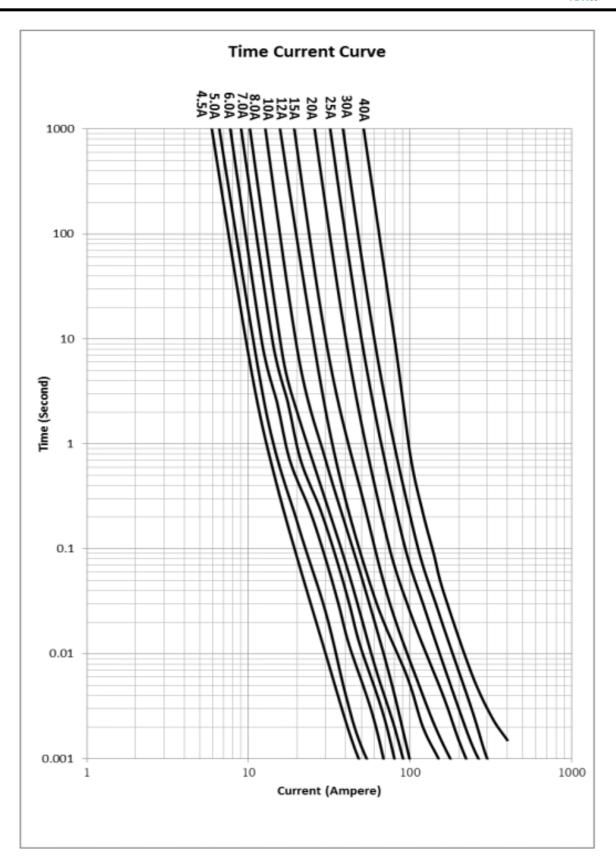
Unit: mm(inch)



















## **Soldering method**

> Wave solder

■ Reservoir temperature: 260°C

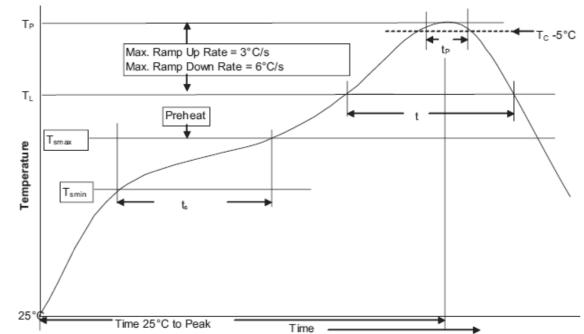
■ Time in reservoir: 10 seconds maximum

> Infrared reflow

■ Temperature: 260°C

■ Time: 30 seconds maximum

## Solder reflow profile



Time 25 C to Peak Time					
Profile Feature	Lead(Pb) free solder				
Preheat and soak	<ul> <li>Temperature min.(T<sub>smin</sub>)</li> </ul>	150℃			
	<ul> <li>Temperature max. (T<sub>smax</sub>)</li> </ul>	200°C			
	<ul> <li>Time (T<sub>smin</sub> to T<sub>smax</sub>) (t<sub>S</sub>)</li> </ul>	60 - 120 Seconds			
Average ramp up rate T <sub>smax</sub> to T	3°C / Second Max.				
Liquidous temperature (T <sub>L</sub> ) Time at liquidous (t <sub>L</sub> )	217°C 60 - 150 Seconds				
Peak package body temperature	260°C				
Time (t <sub>P</sub> ) within 5°C of the specif	30 Seconds				
Average ramp-down rate (T <sub>P</sub> to	6°C / Second Max.				
Time (25°C to Peak Temperature	8 Minutes Max.				





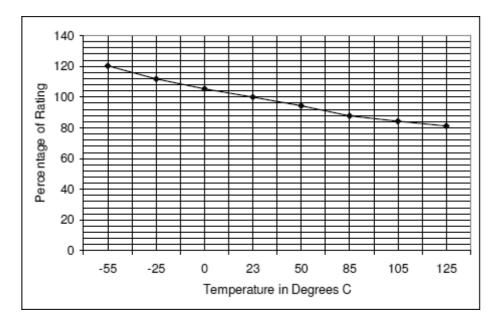




#### **Temperature Derating Curve**

Normal ambient temperature: 23+/-3°C

Operating temperature: -55 ~ 125°C, with proper correction factor applied



#### Package

3000 fuses on 8mm tape-and-reel on a 7 inch (178mm) reel per EIA Standard 481.

--- End of Document ---